

WSD2068DN23

Dual N-Ch MOSFET

General Description

The WSD2068DN23 is the highest performance trench N-ch MOSFETs with extreme high cell density, which provide excellent RDSON and gate charge for most of the small power switching and load switch applications.

The WSD2068 meet the RoHS and Green Product requirement with full function reliability approved.

Features

- Advanced high cell density Trench technology
- Super Low Gate Charge
- Excellent Cdv/dt effect decline
- Green Device Available

Product Summery

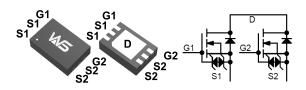
BV _{DSS}	R _{DSON}	I _D
20V	15.5mΩ	7.5A

Applications

• Power Management in Notebook Computer, Portable Equipment and Battery Powered Systems.

- DC-DC Power System
- ESD:2KV

DFN2X3A_EP Pin Configuration



Absolute Maximum Ratings

Symbol	Parameter	Rating	Units
V _{DS}	Drain-Source Voltage	20	V
V _{GS}	Gate-Source Voltage	±12	V
I _D @T _A =25℃	Continuous Drain Current, V _{GS} @ 4.5V ¹	7.5	А
I _D @T _A =70℃	Continuous Drain Current, V _{GS} @ 4.5V ¹	6.5	А
I _{DM}	Pulsed Drain Current ²	30	А
P₀@T _A =25℃	Total Power Dissipation ³	1.5	W
P _D @T _A =70℃	Total Power Dissipation ³	1.0	W
T _{STG}	Storage Temperature Range	-55 to 150	°C
TJ	Operating Junction Temperature Range	-55 to 150	°C

Thermal Data

Symbol	Parameter	Тур.	Max.	Unit
R _{0JA}	Thermal Resistance Junction-ambient ¹ (Steady State)		120	°C/W
R _{0JA}	Thermal Resistance Junction-ambient ¹ (t<10S)		83	℃/W



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Electrical Characteristics (T_J=25⁻¹C, unless otherwise noted)

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
BV _{DSS}	Drain-Source Breakdown Voltage	V _{GS} =0V , I _D =250uA	20			V
$\triangle BV_{DSS} / \triangle T_J$	BVDSS Temperature Coefficient	Reference to 25 $^\circ\!\mathrm{C}$, $I_D\text{=}1\text{mA}$		0.022		V/℃
Б	Static Drain-Source On-Resistance ²	V _{GS} =4.5V , I _D =5.5A		12	15.5	mΩ
R _{DS(ON)}		V _{GS} =2.5V , I _D =5.5A		16	20	
V _{GS(th)}	Gate Threshold Voltage		0.3	0.7	1.0	V
$ riangle V_{GS(th)}$	V _{GS(th)} Temperature Coefficient	$V_{GS}=V_{DS}$, $I_{D}=250$ uA		-2.32		mV/°C
	Drain-Source Leakage Current	V _{DS} =16V , V _{GS} =0V , T _J =25°C			1	
I _{DSS}		V _{DS} =16V , V _{GS} =0V , T _J =55°C			5	uA
I _{GSS}	Gate-Source Leakage Current	$V_{GS}=\pm12V$, $V_{DS}=0V$			±100	nA
gfs	Forward Transconductance	V _{DS} =5V , I _D =10A		20		S
R _g	Gate Resistance	V_{DS} =0V , V_{GS} =0V , f=1MHz		11		Ω
Qg	Total Gate Charge (4.5V)	V _{DS} =10V , V _{GS} =4.5V , I _D =5A		15	20	
Q _{gs}	Gate-Source Charge			2.2		nC
Q _{gd}	Gate-Drain Charge			4.2		
T _{d(on)}	Turn-On Delay Time			148		
Tr	Rise Time	V_{DS} =10V , V_{GS} =10V , R_{G} =6 Ω ,		277		ns
T _{d(off)}	Turn-Off Delay Time	I _D =5A ,RL=2Ω		1616		
T _f	Fall Time		751			
C _{iss}	Input Capacitance	V _{DS} =10V , V _{GS} =0V , f=1MHz		1219	1350	
Coss	Output Capacitance			150		pF
C _{rss}	Reverse Transfer Capacitance			123		

Diode Characteristics

Symbol	Parameter	Conditions	Min.	Тур.	Max.	Unit
Is	Continuous Source Current ^{1,4}				5	А
I _{SM}	Pulsed Source Current ^{2,4}	V _G =V _D =0V , Force Current			15	А
V _{SD}	Diode Forward Voltage ²	V _{GS} =0V , I _S =1A , T _J =25℃		0.76	1.3	V
t _{rr}	Reverse Recovery Time			245		nS
Q _{rr}	Reverse Recovery Charge	lF=5A,dl/dt=100A/µs , Tյ=25℃		1105		nC

Note :

1. The data tested by surface mounted on a 1 inch² FR-4 board with 2OZ copper, t<10sec.

2.The data tested by pulsed , pulse width \leq 300us , duty cycle \leq 2%

3.The power dissipation is limited by 150 $^\circ\!\!\!\mathrm{C}$ junction temperature

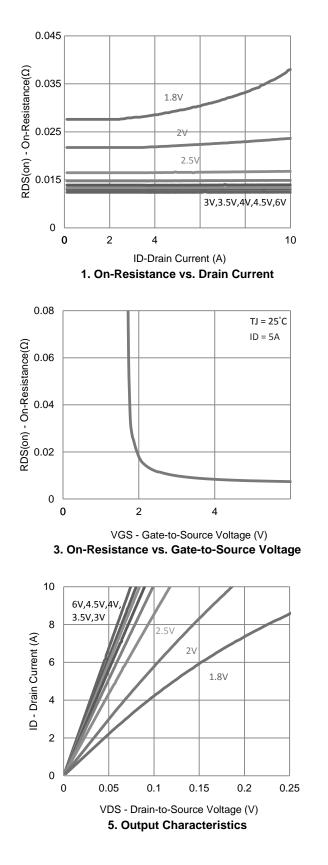
4. The data is theoretically the same as I_D and I_{DM} , in real applications, should be limited by total power dissipation.

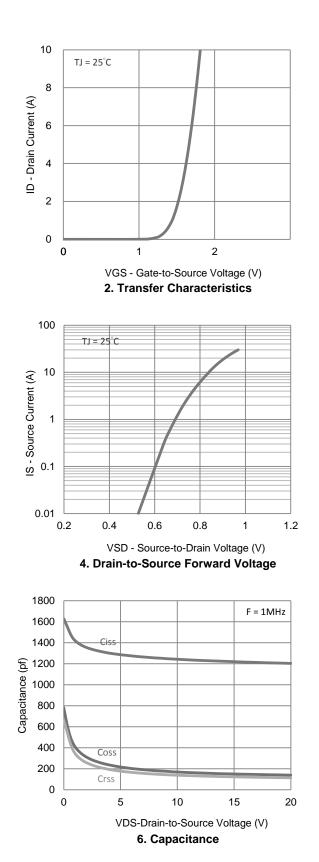


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Typical Characteristics



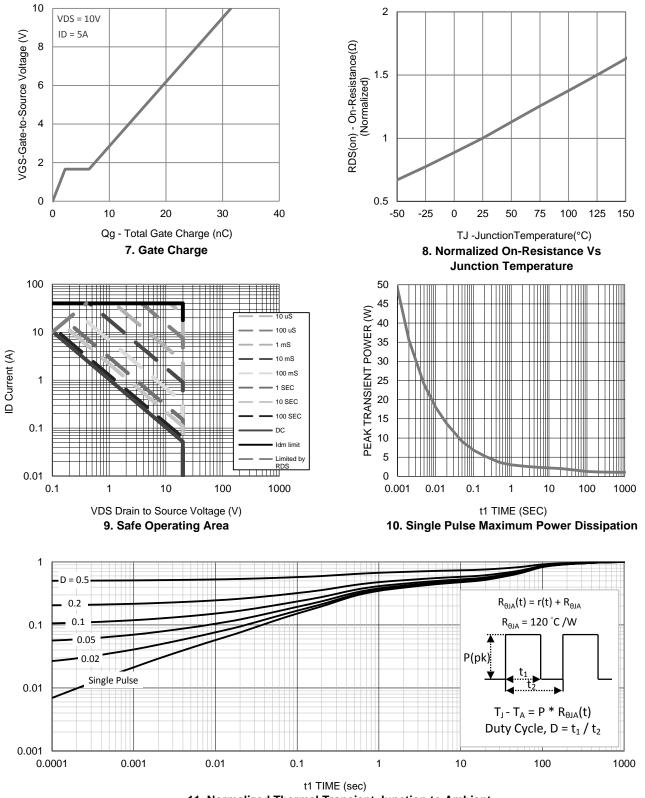




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Typical Characteristics



11. Normalized Thermal Transient Junction to Ambient



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